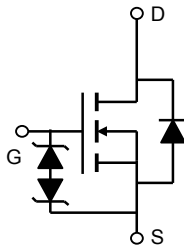
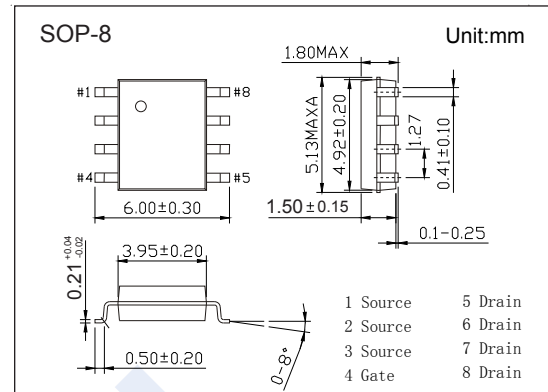


## N-Channel MOSFET

## AO4480 (KO4480)

## ■ Features

- $V_{DS} (V) = 40V$
- $I_D = 14 A (V_{GS} = 10V)$
- $R_{DS(ON)} < 11.5m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 15.5m\Omega (V_{GS} = 4.5V)$
- ESD Rating: 4KV HBM

■ Absolute Maximum Ratings  $T_a = 25^\circ C$ 

| Parameter                               | Symbol     | Rating           | Unit       |              |
|---|------------|------------------|------------|--------------|
| Drain-Source Voltage                    | $V_{DS}$   | 40               | V          |              |
| Gate-Source Voltage                     | $V_{GS}$   | $\pm 20$         |            |              |
| Continuous Drain Current                | $I_D$      | $T_A=25^\circ C$ | 14         | A            |
|   |            | $T_A=70^\circ C$ | 11         |              |
| Pulsed Drain Current                    | $I_{DM}$   | 70               |            |              |
| Avalanche Current                       | $I_{AR}$   | 30               |            |              |
| Repetitive Avalanche Energy             | $L=0.3mH$  | $E_{AR}$         | 135        | mJ           |
| Power Dissipation                       | $P_D$      | $T_A=25^\circ C$ | 3.1        | W            |
|   |            | $T_A=70^\circ C$ | 2          |              |
| Thermal Resistance.Junction- to-Ambient | $R_{thJA}$ | $t \leq 10s$     | 40         | $^\circ C/W$ |
|   |            | Steady-State     | 75         |              |
| Thermal Resistance.Junction- to-Lead    | $R_{thJL}$ | 24               |            |              |
| Junction Temperature                    | $T_J$      | 150              | $^\circ C$ |              |
| Storage Temperature Range               | $T_{stg}$  | -55 to 150       |            |              |

## N-Channel MOSFET

### AO4480 (KO4480)

#### ■ Electrical Characteristics Ta = 25°C

| Parameter                             | Symbol              | Test Conditions   | Min             | Typ  | Max  | Unit |  |
|---------------------------------------|---------------------|---|-----------------|------|------|------|--|
| Drain-Source Breakdown Voltage        | V <sub>DSS</sub>    | I <sub>D</sub> =250 μA, V <sub>GS</sub> =0V   | 40              |      |      | V    |  |
| Zero Gate Voltage Drain Current       | I <sub>DSS</sub>    | V <sub>DS</sub> =32V, V <sub>GS</sub> =0V   |                 |      | 1    | μA   |  |
|                                       |                     | V <sub>DS</sub> =32V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C                           |                 |      | 5    |      |  |
| Gate-Body Leakage Current             | I <sub>GSS</sub>    | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V  |                 |      | ±100 | μA   |  |
| Gate Threshold Voltage                | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                                  | 1               |      | 3    | V    |  |
| Static Drain-Source On-Resistance     | R <sub>DS(on)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =14A   |                 |      | 11.5 | mΩ   |  |
|                                       |                     | V <sub>GS</sub> =10V, I <sub>D</sub> =14A, T <sub>J</sub> =125°C                          |                 | 13   |      |      |  |
|                                       |                     | V <sub>GS</sub> =4.5V, I <sub>D</sub> =5A   |                 |      | 15.5 |      |  |
| On State Drain Current                | I <sub>D(on)</sub>  | V <sub>GS</sub> =10V, V <sub>DS</sub> =5V   | 70              |      |      | A    |  |
| Forward Transconductance              | g <sub>FS</sub>     | V <sub>DS</sub> =5V, I <sub>D</sub> =5A   | 50              |      |      | S    |  |
| Input Capacitance                     | C <sub>iss</sub>    | V <sub>GS</sub> =0V, V <sub>DS</sub> =20V, f=1MHz   |                 | 1600 | 1920 | pF   |  |
| Output Capacitance                    | C <sub>oss</sub>    |   |                 | 320  |      |      |  |
| Reverse Transfer Capacitance          | C <sub>rss</sub>    |   |                 | 100  |      |      |  |
| Gate Resistance                       | R <sub>g</sub>      | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz  |                 | 3.4  |      | Ω    |  |
| Total Gate Charge (10V)               | Q <sub>g</sub>      | V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, I <sub>D</sub> =14A                           |                 | 22   |      | nC   |  |
| Total Gate Charge (4.5V)              |                     |   |                 | 10.5 |      |      |  |
| Gate Source Charge                    |                     |   | Q <sub>gs</sub> |      | 4.2  |      |  |
| Gate Drain Charge                     |                     |   | Q <sub>gd</sub> |      | 4.8  |      |  |
| Turn-On DelayTime                     | t <sub>d(on)</sub>  | V <sub>GS</sub> =10V, V <sub>DS</sub> =20V, R <sub>L</sub> =1.5Ω,<br>R <sub>GEN</sub> =3Ω |                 | 3.5  |      | ns   |  |
| Turn-On Rise Time                     | t <sub>r</sub>      |   |                 | 6    |      |      |  |
| Turn-Off DelayTime                    | t <sub>d(off)</sub> |   |                 | 13.2 |      |      |  |
| Turn-Off Fall Time                    | t <sub>f</sub>      |   |                 | 3.5  |      |      |  |
| Body Diode Reverse Recovery Time      | t <sub>rr</sub>     | I <sub>F</sub> = 14A, di/dt= 100A/us  |                 | 31   |      | nC   |  |
| Body Diode Reverse Recovery Charge    | Q <sub>rr</sub>     |   |                 | 33   |      |      |  |
| Maximum Body-Diode Continuous Current | I <sub>S</sub>      |   |                 |      | 4    | A    |  |
| Diode Forward Voltage                 | V <sub>SD</sub>     | I <sub>S</sub> =1A, V <sub>GS</sub> =0V   |                 |      | 1    | V    |  |

Note : The static characteristics in Figures 1 to 6 are obtained using <300 us pulses, duty cycle 0.5% max.

#### ■ Marking

|         |        |
|---------|--------|
| Marking | 4480   |
|         | KC**** |

### N-Channel MOSFET

### AO4480 (KO4480)

■ Typical Characteristics

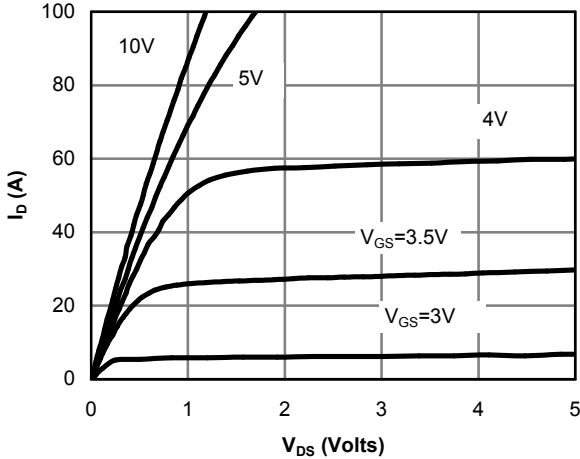


Figure 1: On-Region Characteristics

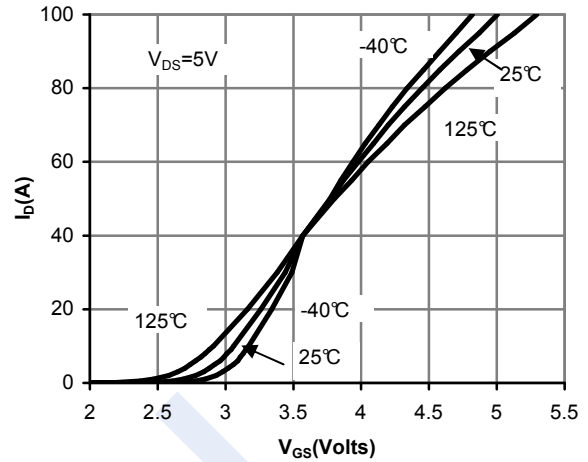


Figure 2: Transfer Characteristics

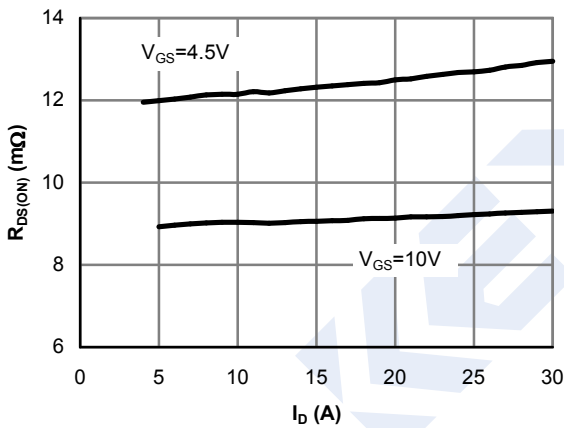


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

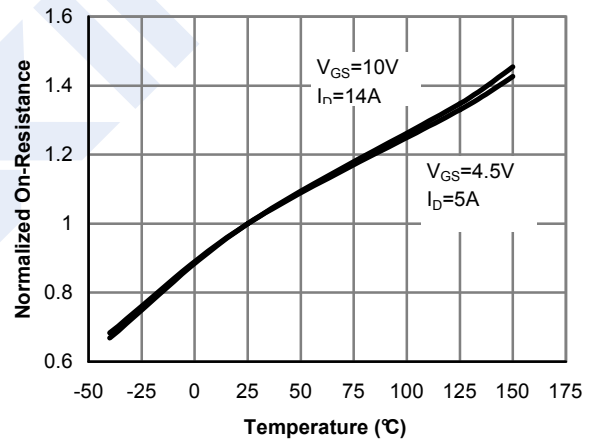


Figure 4: On-Resistance vs. Junction Temperature

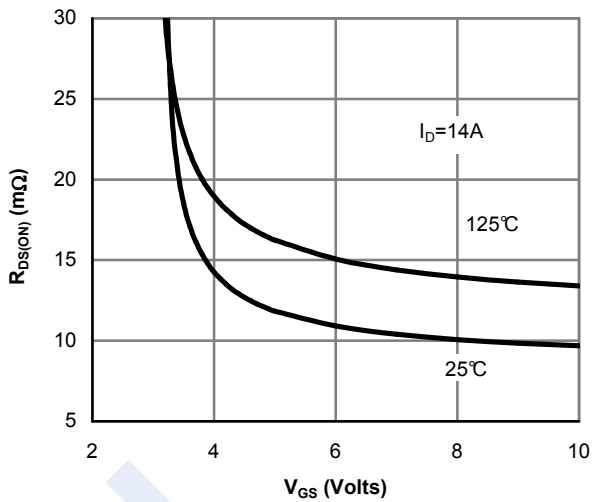


Figure 5: On-Resistance vs. Gate-Source Voltage

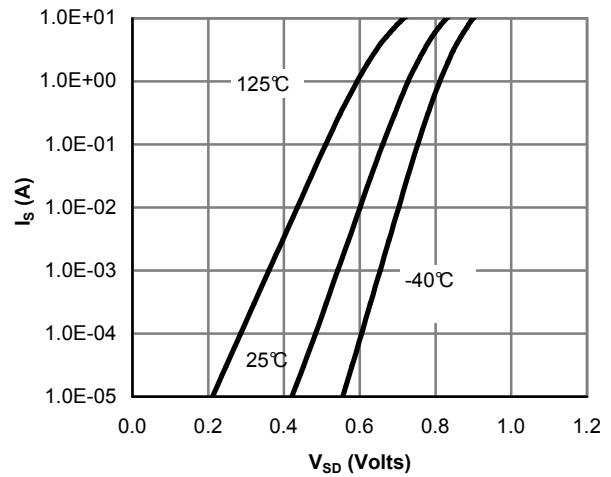


Figure 6: Body-Diode Characteristics

## N-Channel MOSFET AO4480 (KO4480)

■ Typical Characteristics

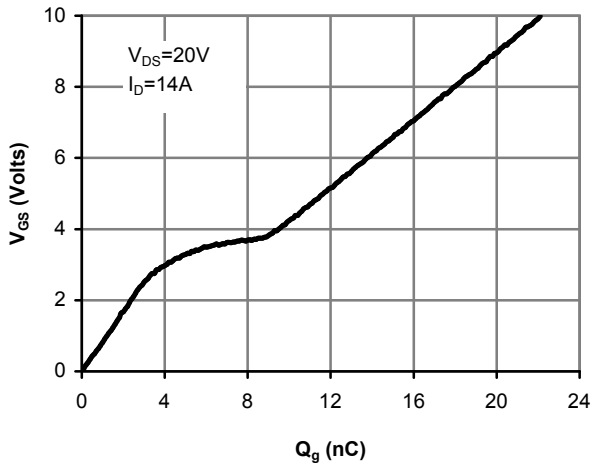


Figure 7: Gate-Charge Characteristics

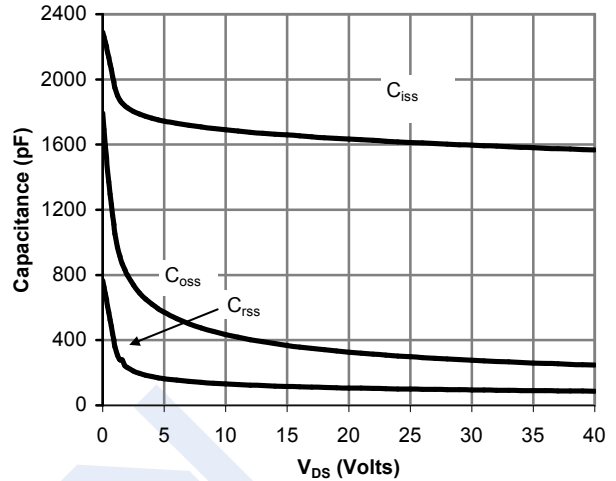


Figure 8: Capacitance Characteristics

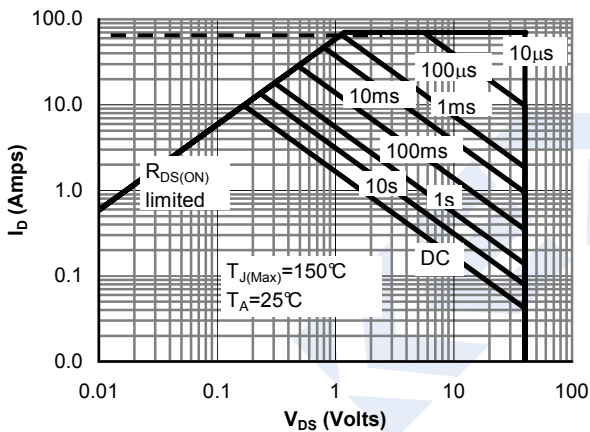


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

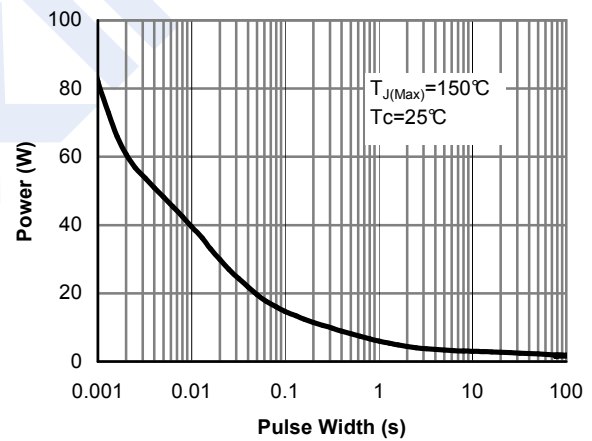


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

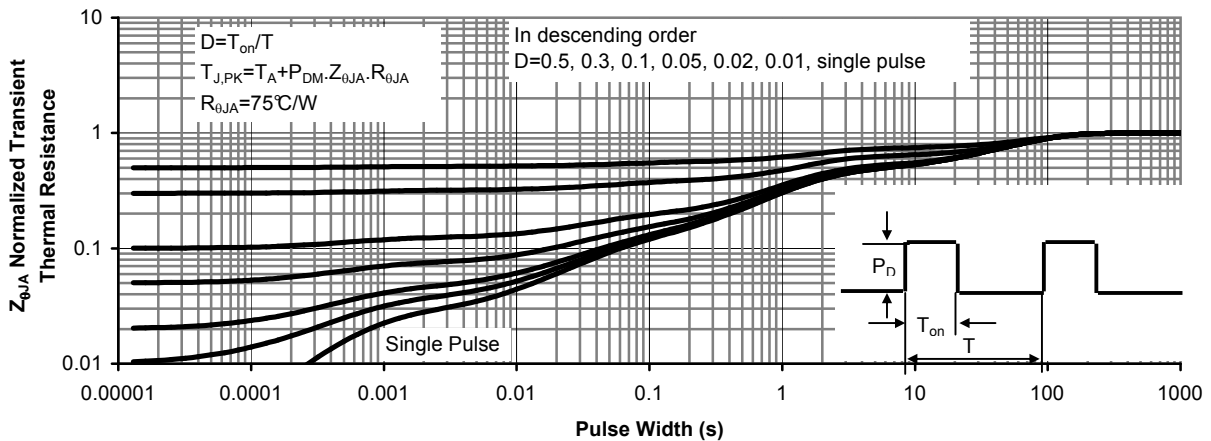


Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)